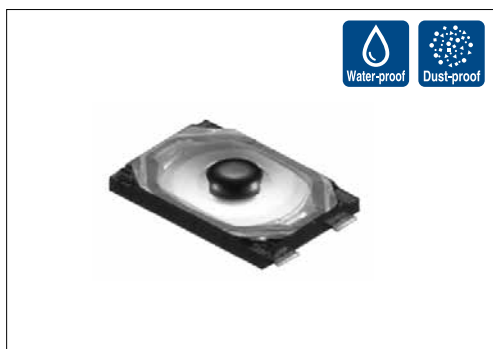


Width of 1.9mm contributes to thinner product designs and greater mounting efficiency



Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10 μ A 1V DC
Initial contact resistance	500m Ω max.
Travel (mm)	0.12
Protective structure ※	IP67 equivalent

Product Line

Product No.	Operating force	Operating direction	Operating life (5mA 5V DC)	Minimum order unit (pcs.)	
				Japan	Export
SKSVCAE010	1.6N	Top push	300,000 cycles	20,000	20,000
SKSVCCE010	2.2N		100,000 cycles		

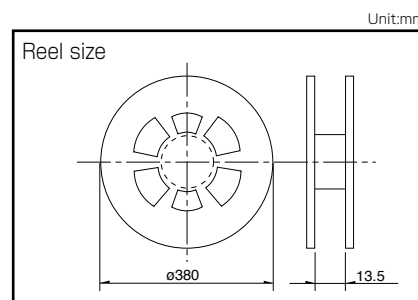
Packing Specifications

Taping

Number of packages (pcs.)			Tape width (mm)	Export package measurements (mm)
1 reel	1 case / Japan	1 case / export packing		
20,000	200,000	200,000	12	395×395×205

Note

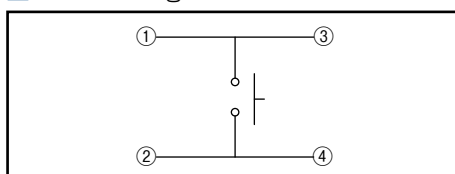
For reels of 330mm diameter, please inquire.



Dimensions

Style	PC board mounting hole and land dimensions (Viewed from switch mounting face)

Circuit Diagram



※ Assumes the switch is left alone without being operated. Under the specified conditions, dust and water ingress with a significant impact on the switch's on-off function is prevented.
IP67 dust and water resistance is guaranteed for the switch alone and performance may not be guaranteed depending on the mounting conditions and usage.

Refer to P.249 for soldering conditions.

TACT Switch™

List of Varieties

TACT Switch™

Sharp Feeling

Soft Feeling

Snap-in Type

Surface Mount Type

Radial Type

Type		Sharp Feeling Type						
		Surface Mount						
Series		SKSD	SKRN	SKTA	SKSV	SKSW	SKTK	SKSG
Photo								
Features		Double action		Compact size Low-profile			Long life	High operation force Compact size
Water-proof		—	—	●	●	●	●	—
Dust-proof		—	—	●	●	●	●	—
IP standard		—	—	67 equivalent 68 equivalent in some cases	67 equivalent	67 equivalent 68 equivalent in some cases	67 equivalent	—
Operating direction	Top push	●	●	●	●	●	●	●
	Side push	—	—	—	—	—	—	—
Dimensions (mm)	W	4.1	□6	2.6	2.8	3	5.9	3
	D	3.9		1.6	1.9	2	4	2.7
	H	0.6		0.9	0.53	0.55	0.6	0.78
Operation force coverage	1N max.	See the relevant pages for respective product descriptions						
	1N to 2N							
	2N to 3N							
	3N to 4N							
	4N to 5N							
Travel (mm)		See the relevant pages for respective product descriptions		0.11	0.12	See the relevant pages for respective product descriptions	0.25	0.12
Ground terminal		●	●	—	—	—	—	○
Operating temperature range		−40℃ to +90℃		−30℃ to +85℃				−40℃ to +85℃
Automotive use		—	—	—	—	—	—	●
Life Cycle								
Electrical performance	Rating (max.) (Resistive load)	50mA 12V DC						
	Rating (min.) (Resistive load)	10μA 1V DC						
	Insulation resistance	100MΩ min. 100V DC 1min.						
	Voltage proof	100V AC 1min.	250V AC 1min.	100V AC 1min.				
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively						
	Lifetime	Shall be in accordance with individual specifications.						
Environmental performance	Cold	−40℃ 96h						
	Dry heat	90℃ 96h						
	Damp heat	60℃, 90 to 95%RH 96h						
Page		208	209	210	212	213	215	216

W : Width. The most outer dimension excluding terminal portion.
D : Depth. The most outer dimension excluding terminal portion.
H : Height. The minimum dimension if there are variances.

TACT Switch™ Soldering Conditions	249
TACT Switch™ Cautions	250

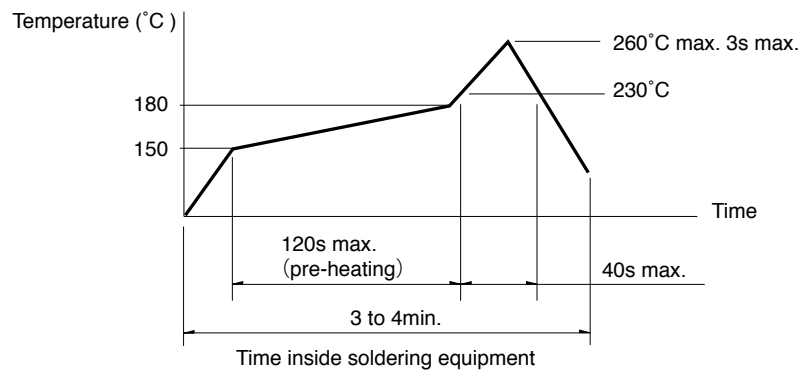
Notes

- The automotive operating temperature range to be individually discussed upon request.
- Indicates applicability to all products in the series, while ○ indicates applicability to some products in the series.

■ Condition for Reflow

Available for Surface Mount Type.

Temperature profile



Notes

1. Please confirm the specifications of our product for the detailed condition.
2. Soldering conditions differ depending on reflow soldering machines.
Prior verification of soldering condition is highly recommended.

■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHLTop Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Prevent flux penetration from the top side of the TACT Switch™.
2. Switch terminals and a PC board should not be coated with flux prior to soldering.
3. The second soldering should be done after the switch is stable with normal temperature.
4. Use the flux with a specific gravity of min 0.81.
(EC-19S-8 by TAMURA CORPORATION, or equivalents.)

■ Manual Soldering

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9